

## Supplementary information for

# Role of soft-gel substrates on bouncing-merging transition in drop impact on liquid film

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**Table S1.** PAAM composition information with five different wt% of crosslinker.

$C_{BIS}$ (wt%) <sup>1</sup>	$C_{Monomer}$ (wt%) <sup>2</sup>	TEMED(%) <sup>3</sup>	$C_{APS}$ (%) <sup>4</sup>	Vol% of APS in sample <sup>5</sup>
1.5	4.69	0.2117	11.22	0.5
3.0				
6.0				
10.5				
15.0				

<sup>1</sup> N,N-methylene-bis-acrylamide (BIS) wt%, noted as  $C_{BIS}$ (wt%), is defined as  $\left(\frac{w_{BIS}(g)}{w_{monomer}(ml)} \times 100\right)$

<sup>2</sup> Acrylamide monomer wt% is defined as  $C_{monomer}$ (wt%) =  $\left(\frac{w_{monomer}(g)}{w_{H_2O}(ml)} \times 100\right)$ , where deionized water was used.

<sup>3</sup> TEMED(%) is  $\left(\frac{Vol_{TEMED}}{Vol_{batch}} \times 100\right)$ , where the volume of the batch is the volume of premixed solution of monomer, BIS, and deionized water.

<sup>4</sup> APS solution was prepared right before it was used and its concentration was defined as  $C_{APS}$ (%) =  $\left(\frac{w_{APS}(g)}{w_{H_2O}(ml)} \times 100\right)$ , where deionized water was used.

<sup>5</sup> The true APS(%) used for each sample was constant as 0.5% as similar to vol% of TEMED, defined as  $\left(\frac{Vol_{APS}}{Vol_{batch}} \times 100\right)$ .

## Swelling ratio of PAAm

Swelling ratio is defined as  $\lambda = \frac{D_\infty}{D_0}$ , where  $D_\infty$  is the diameter of PAAm in the swollen state and  $D_0$  is the diameter of PAAm in the as-prepared state.  $\lambda$  is related to the crosslinking density of PAAm, thus it decreased as a function of  $C_{BIS}$  until  $C_{BIS} = 6.0$  wt%, while  $C_{BIS} > 6.0$  wt%,  $\lambda$  became independent of  $C_{BIS}$ . This can be explained by the spatial inhomogeneity<sup>1,2</sup> of PAAm that 2<sup>nd</sup> order crosslinking reactions (*i.e.*, multiple crosslinking reactions<sup>3,4</sup>) become dominant, resulting in nonuniform crosslinking density<sup>5</sup> instead of forming new polymer networks (*i.e.*, crosslinking reactions) that affect  $\lambda$  (Fig. S1).

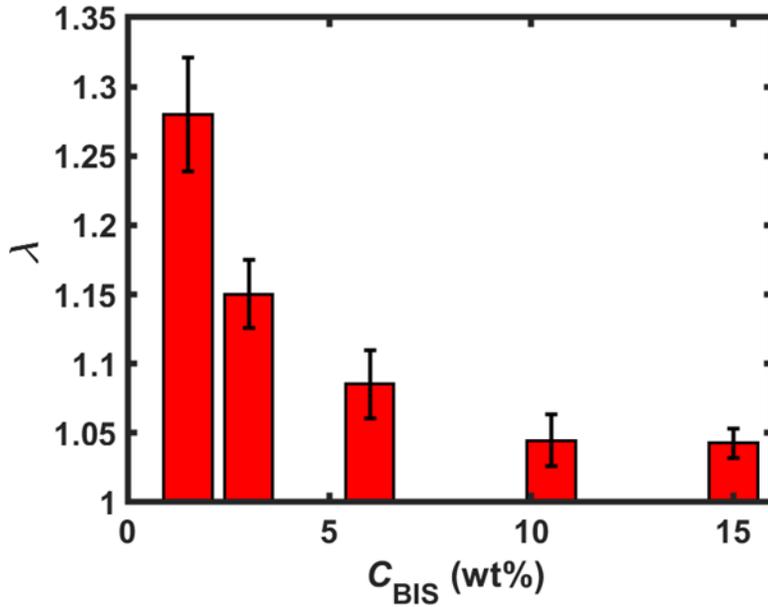
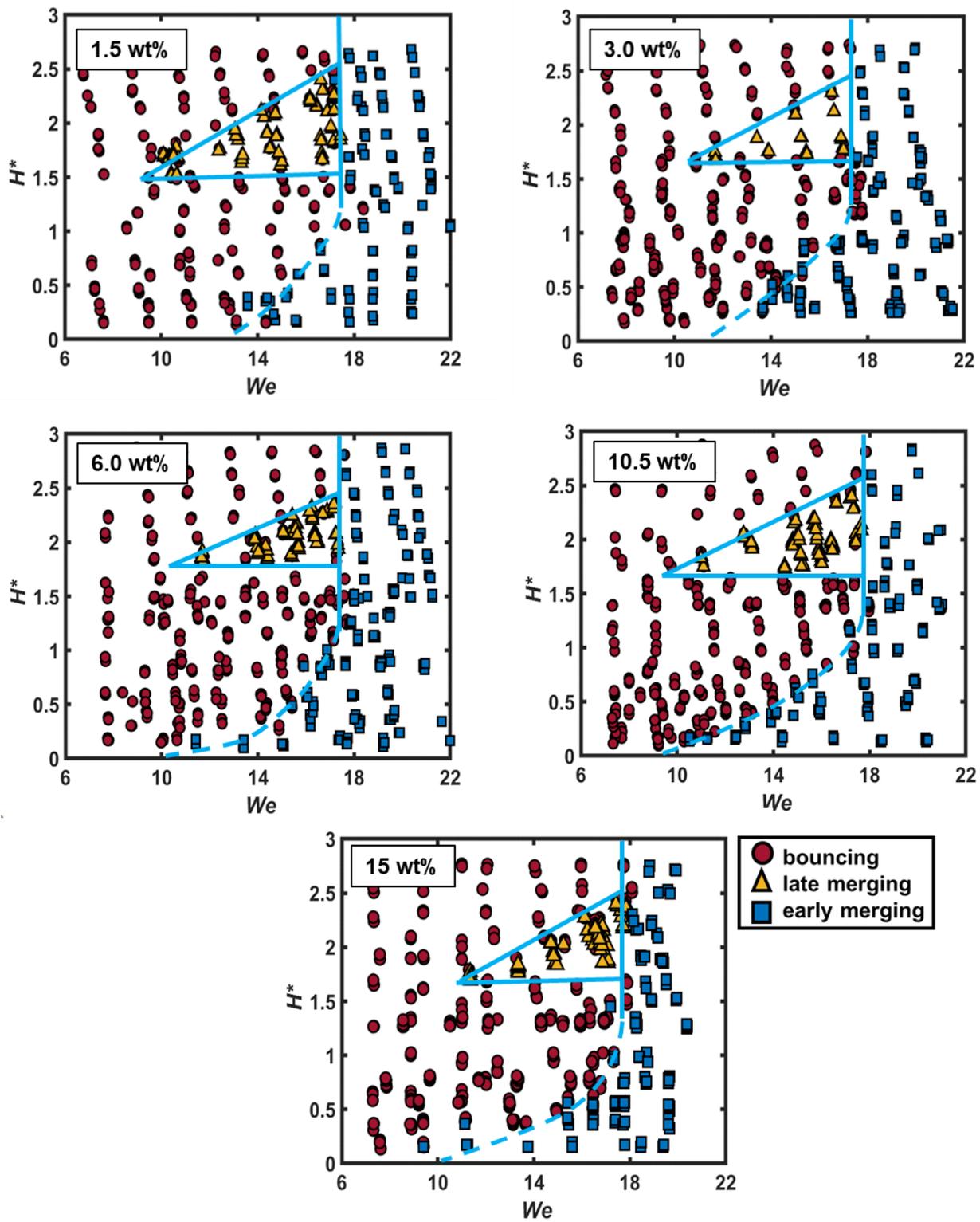


Fig. S1 Swelling ratio ( $\lambda$ ) of PAAm with different wt% of  $C_{BIS}$ .

## Overall droplet regime diagram of PAAm with different $C_{BIS}$ as the soft substrate

We observed no significant difference in  $We_{cr}$  ( $\sim 17$ ) at the transition of bouncing and merging with PAAm substrates prepared by different  $C_{BIS}$  since the droplet does not contact with the hydrogel substrate (*i.e.*, hydrogel substrate does not affect the droplet effect) for the merging in the inertial limit. On the other hand, we obtained the critical changes in  $H^*_{DT}$ ,  $H^*$  for the deformation transition (*i.e.*, transition from bouncing to late merging), with PAAm substrates with different  $C_{BIS}$ . From Fig. S2, PAAm with 1.5 to 6.0 wt%  $C_{BIS}$  showed increases in  $H^*_{DT}$ , leading the late merging phenomena to occur with higher  $H^*$ . As described in the manuscript (Fig. 7b), when  $Y$  increases, deformation of droplet increases thus film thickness ( $H^*$ ) also increases to reach  $\Delta SE_F \geq \Delta SE_D$  (Fig. S2).



**Fig. S2** Overall regime diagrams of PAAM with five different  $C_{BIS}$  (1.5, 3.0, 6.0, 10.5, and 15 wt%) as the soft substrate.

## References

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